

# **LG-ITR2C-262519**

## **DATA SHEET**

SPEC.NO.: SZ18080413  
DATE: 2022/03/04  
REV. A/1

Approved By:

Checked By:

Prepared By:

## ■ Features

- Fast response time
- High analytic
- Cut-off visible wavelength  $\lambda_p=940\text{nm}$
- High sensitivity
- Pb free
- The product itself will remain within RoHS compliant version

## ■ Descriptions

The LG-ITR2C-262519 consist of an infrared emitting diode and an NPN silicon phototransistor, encased side-by-side on converging optical axis in a black Thermoplastic

Housing The phototransistor receives radiation from the IRED only .This is the normal Situation. But when an object is in between , phototransistor could not receives the radiation.

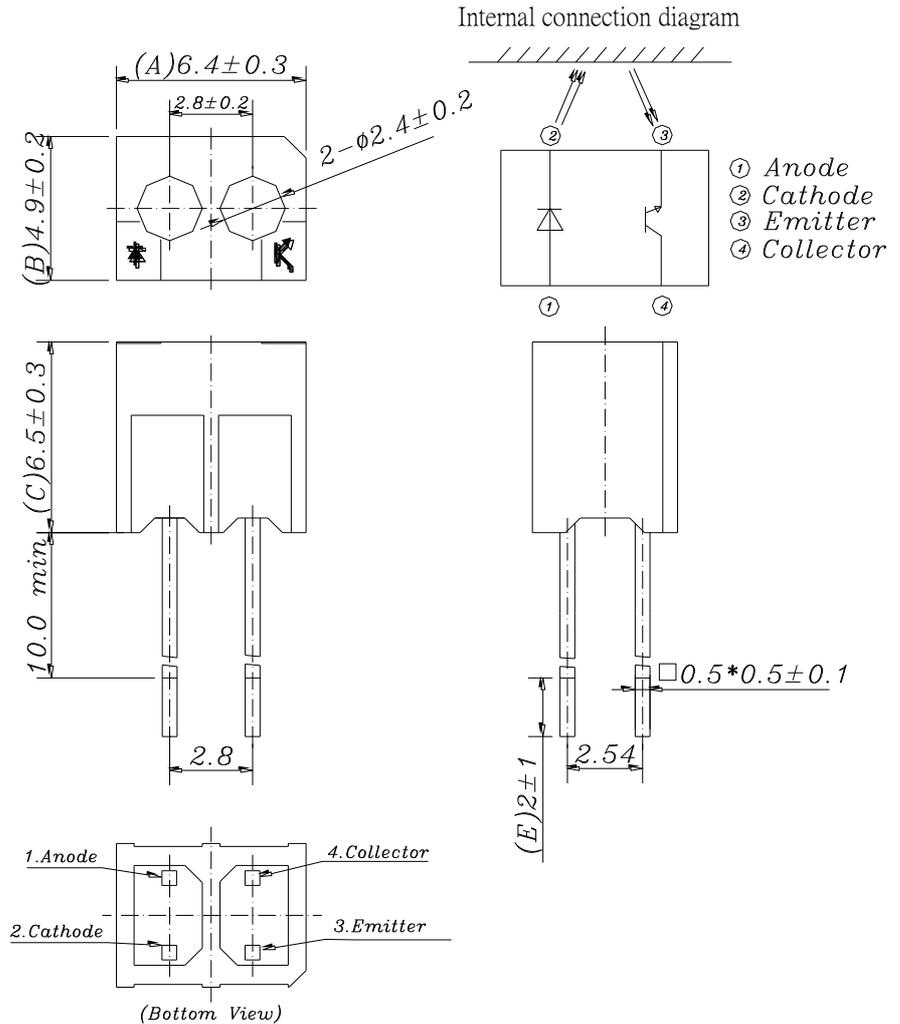
## ■ Applications

- Mouse Copier
- Switch Scanner
- Floppy disk driver
- Non-contact Switching
- For Direct Board

## ■ Device Selection Guide

Device No.	Chip Material	LENS COLOR
IR	GaAlAs	Water Clear
PT	Silicon	Black

## Package Dimensions



### Notes:

1. All dimensions are in millimeters.
2. Tolerances unless dimensions  $\pm 0.25$ mm.
3. Lead spacing is measured where the lead emerge from the package.

### Recommended soldering conditions:

	Wave Soldering (Pb Free)	Soldering Iron
Pre-heat Temperature	100°C Max.	---
Pre-heat Time	60sec. Max.	---
Peak Temperature	260°C Max.	300°C Max.
Dwell Time	5sec. Max. (one time only)	3sec. Max. (one time only)

### Notes:

Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for the LED lamp product.

## Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit
Input	Power Dissipation at(or below) 25°C Free Air Temperature	$P_d$	75	mW
	Reverse Voltage	$V_R$	5	V
	Forward Current	$I_F$	50	mA
	Peak Forward Current(*1) Pulse width $\leq 100\mu s$ , Duty cycle=1%	$I_{FP}$	1	A
Output	Collector Power Dissipation	$P_C$	75	mW
	Collector Current	$I_C$	20	mA
	Collector-Emitter Voltage	$V_{CEO}$	30	V
	Emitter-Collector Voltage	$V_{ECO}$	5	V
Operating Temperature		$T_{opr}$	-25~+85	°C
Storage Temperature		$T_{stg}$	-40~+85	°C
Lead Soldering Temperature (*2) (1/16 inch from body for 5 seconds)		$T_{sol}$	260	°C

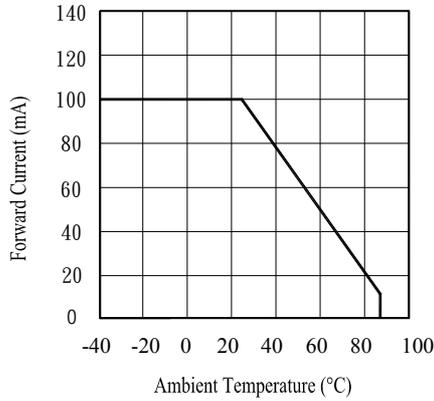
(\*1)  $t_w = 100 \mu sec.$ ,  $T = 10 msec.$  (\*2)  $t = 5 Sec.$

## Electro-Optical Characteristics (Ta=25°C)

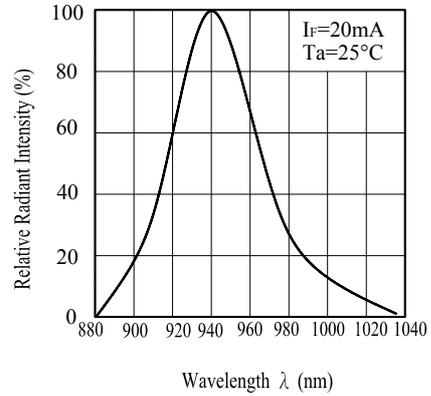
Parameter		Symbol	Min.	Typ.	Max.	Unit	Condition
Input	Forward Voltage	$V_F$	---	1.2	1.6	V	$I_F = 20mA$
	Reverse Current	$I_R$	---	---	10	$\mu A$	$V_R = 5V$
	Peak Wavelength	$\lambda_P$	--	940	---	nm	$I_F = 20mA$
Output	Collector Dark Current	$I_{CEO}$	---	---	100	nA	$V_{CE} = 10V$ , $E_e = 0mW/cm^2$
	C-E Saturation Voltage	$V_{CE(sat)}$	---	---	0.4	V	$I_C = 0.5mA$ $E_e = 10mW/cm^2$
	Collector Current	$I_C(ON)$	0.2	0.5	---	mA	$V_{CE} = 5V$ $I_F = 20mA$
Transfer Characteristic	Rise time	$t_r$	---	15	---	$\mu sec$	$V_{CE} = 5V$
	Fall time	$t_f$	---	15	---	$\mu sec$	$I_C = 1mA$ $R_L = 1K\Omega$

**Typical Electrical/Optical/Characteristics Curves for IR**

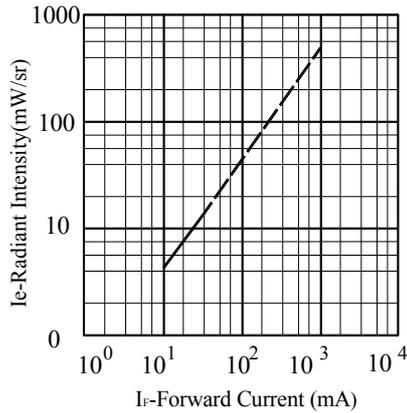
**Fig.1 Forward Current vs. Ambient Temperature**



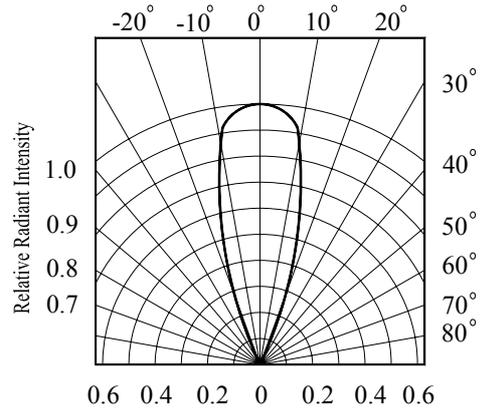
**Fig.2 Spectral Distribution**



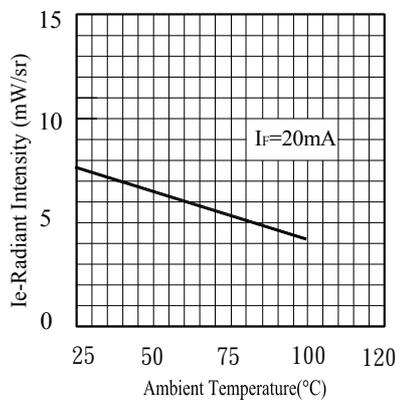
**Fig.3 Relative Intensity vs. Forward Current**



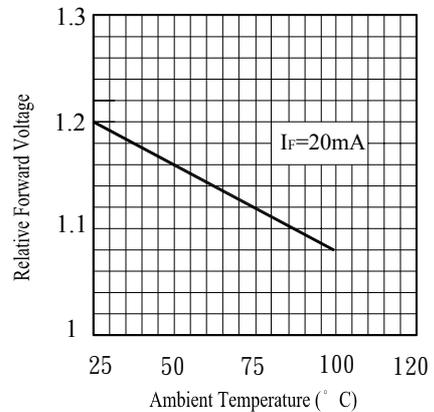
**Fig.4 Relative Radiant Intensity vs. Angular Displacement**



**Fig.5 Relative Intensity vs. Ambient Temperature(°C)**



**Fig.6 Forward Current vs. Ambient Temperature(°C)**



## Typical Electrical/Optical/Characteristics Curves for PT

Fig.1 Collector Power Dissipation vs.

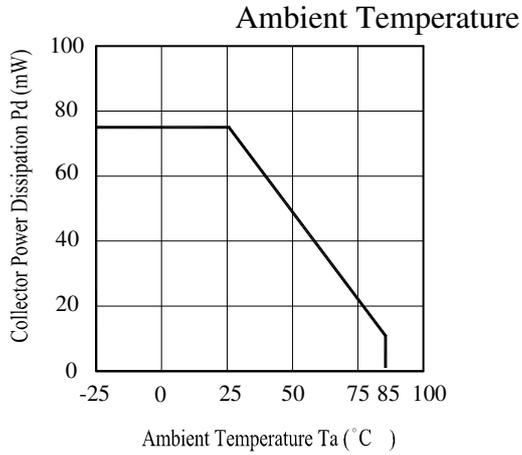


Fig.2 Spectral Sensitivity

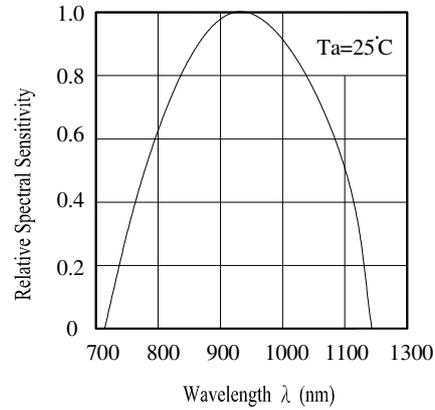


Fig.3 Relative Collector Current vs.

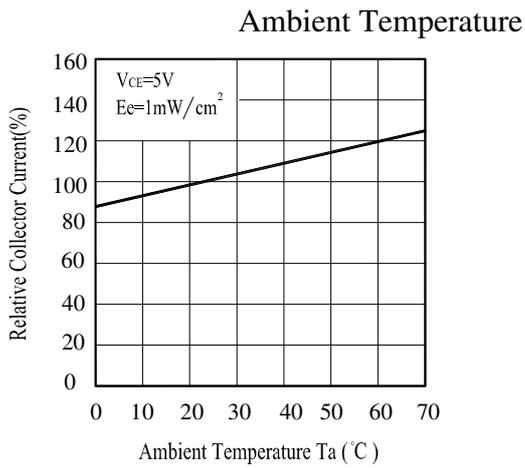


Fig.4 Collector Current vs.

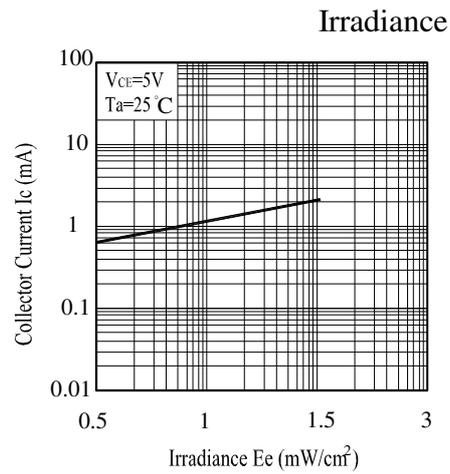


Fig.5 Collector Dark Current vs.

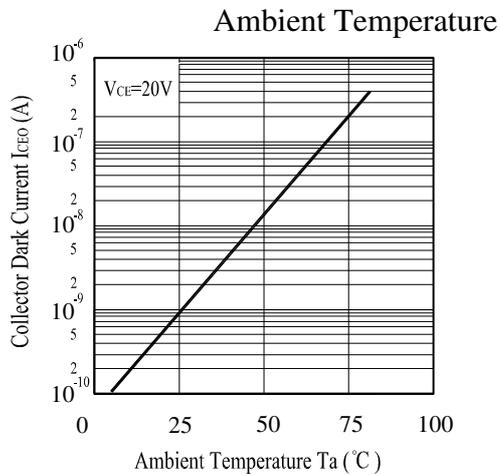


Fig.6 Collector Current vs.

